

A

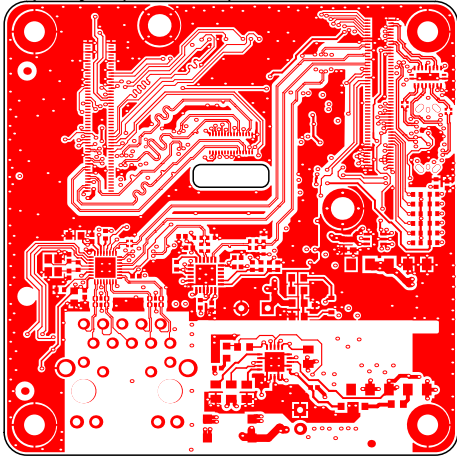
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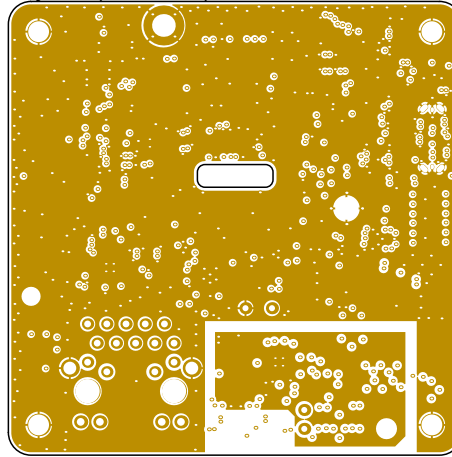
D

E

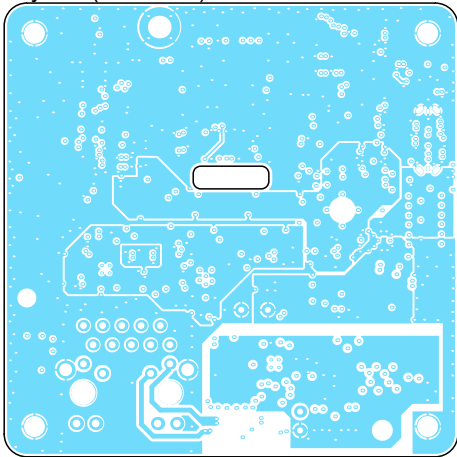
Top Layer (Scale 1:1)



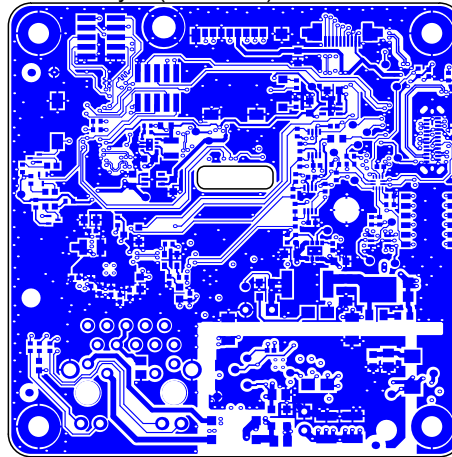
Layer 2 (Scale 1:1)



Layer 3 (Scale 1:1)



Bottom Layer (Scale 1:1)

**FABRICATION NOTES:**

Fabricate per IPC-6011 & IPC-6012 CLASS 2
Inspect per IPC-A-600 CLASS 2
Test per IPC-TM-650

- * PCB has 4 copper layers
- * Copper thicknesses are finished and include base foil plus Cu plating on plated layers.
- * PCB thickness: 63mil +/- 3mil
- * Min. trace width/clearance: 4/4mil
- * Min. hole drill/ring: 8mil/16mil
- * All vias-in-pad shall be plugged and plated over (VIPPO)
- * Soldermask gang relief is allowed for pads in same footprint, if footprint is NSMD.
- * Silkscreen, non-conductive epoxy ink, color: white
- * Remove silkscreen as needed to prevent ink on any exposed copper
- * Surface finish: ENIG
- * Hole dimensions are finished size, +/-3mil
- * Linear board dimension tolerance: +/-10mil
- * Bow, twist, warp not to exceed 0.75% of greatest diagonal span
- * PCB shall be UL Recognized printed wiring board (ZPMV2), minimum flammability rating 94V-0
- * PCB shall be marked with fabricator company or trade name, UL mark, and date code using legend ink on secondary side
- * All PCBs shall be electrically tested for opens and shorts per gerber. Test marking shall be marked on secondard side.

Fabricator shall panelize the PCB using mouse bites and tab routing. V-scoring not allowed.

Controlled impedance differential pairs shall be within +/-10% of target impedance. See sheets below for more detail.

Title: **SJ2098POE**Number: D2098000 Revision: R0M0
E0

Date: 6/01/2021 Sheet: 1 of 4

Drawn by: BW / MB / SJ

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A

B

C

D

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Layer Stack Legend

Layer	Thickness	Type	Gerber	Df	Dk
Top Overlay		Legend	GTO		
Top Solder	0.59mil(0.015mm)	Solder Mask	GTS		3.8
Top Layer	1.69mil(0.043mm)	Signal	GTL		
	8.27mil(0.210mm)	Dielectric		0.013	4.2
Layer 2	1.42mil(0.036mm)	Signal	G1		
	39.37mil(1.000mm)	Dielectric		0.013	4.2
Layer 3	1.42mil(0.036mm)	Signal	G2		
	8.27mil(0.210mm)	Dielectric		0.013	4.2
Bottom Layer	1.69mil(0.043mm)	Signal	GBL		
Bottom Solder	0.59mil(0.015mm)	Solder Mask	GBS		3.8
Bottom Overlay		Legend	GBO		
Total thickness: 63.31mil(1.608mm)					

Drill Table

Symbol	Count	Hole Size	Plated	Hole Tolerance
⊙	10	8.00mil(0.203mm)	Plated	None
☆	687	10.00mil(0.254mm)	Plated	None
○	2	17.72mil(0.450mm)	Plated	None
□	4	27.56mil(0.700mm)	Plated	None
◇	4	31.50mil(0.800mm)	Plated	None
☆	14	35.43mil(0.900mm)	Plated	None
◇	4	40.16mil(1.020mm)	Plated	None
⊕	2	66.93mil(1.700mm)	Plated	None
☆	2	78.74mil(2.000mm)	Plated	None
⊞	4	108.27mil(2.750mm)	Plated	None
△	2	118.11mil(3.000mm)	Plated	None
⊗	2	125.98mil(3.200mm)	Plated	None
737 Total				

Title: **SJ2098POE**

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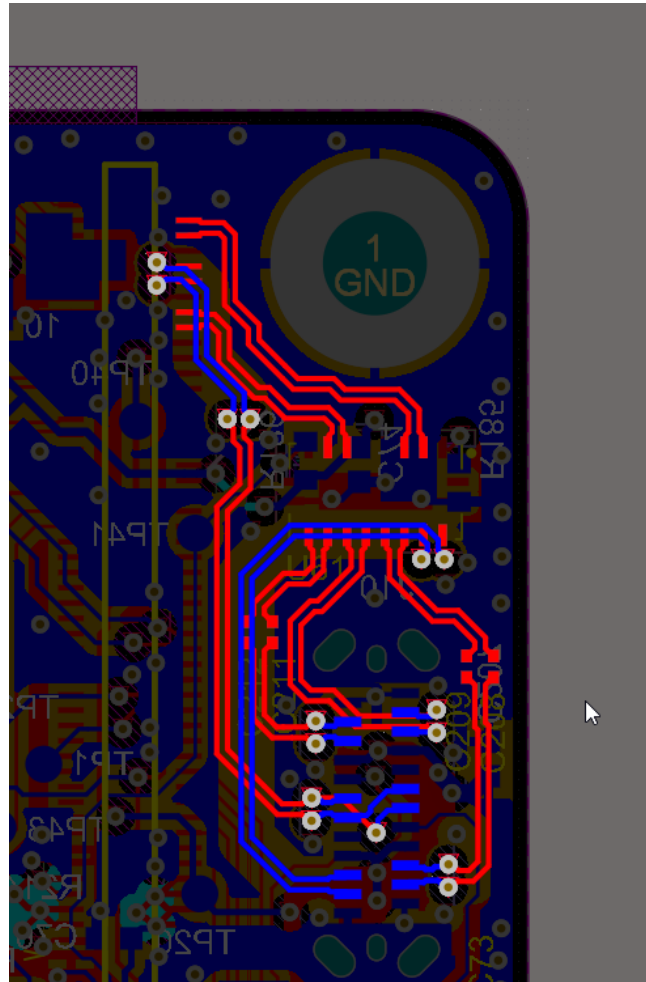
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90 OHM (+/-10%) DIFF PAIRS

USB differential pairs



Transmission Line Structure Table

Target Impedance	Calculated Impedance	Trace layer	Lower Trace Width	Upper Trace Width	Gap	Reference layers
90	91.41	Top Layer	7.0mil(0.178mm)	7.0mil(0.178mm)	4.0mil(0.102mm)	Layer 2
90	91.41	Bottom Layer	7.0mil(0.178mm)	7.0mil(0.178mm)	4.0mil(0.102mm)	Layer 3

Title: **SJ2098POE**Number: D2098000 Revision: R0M0
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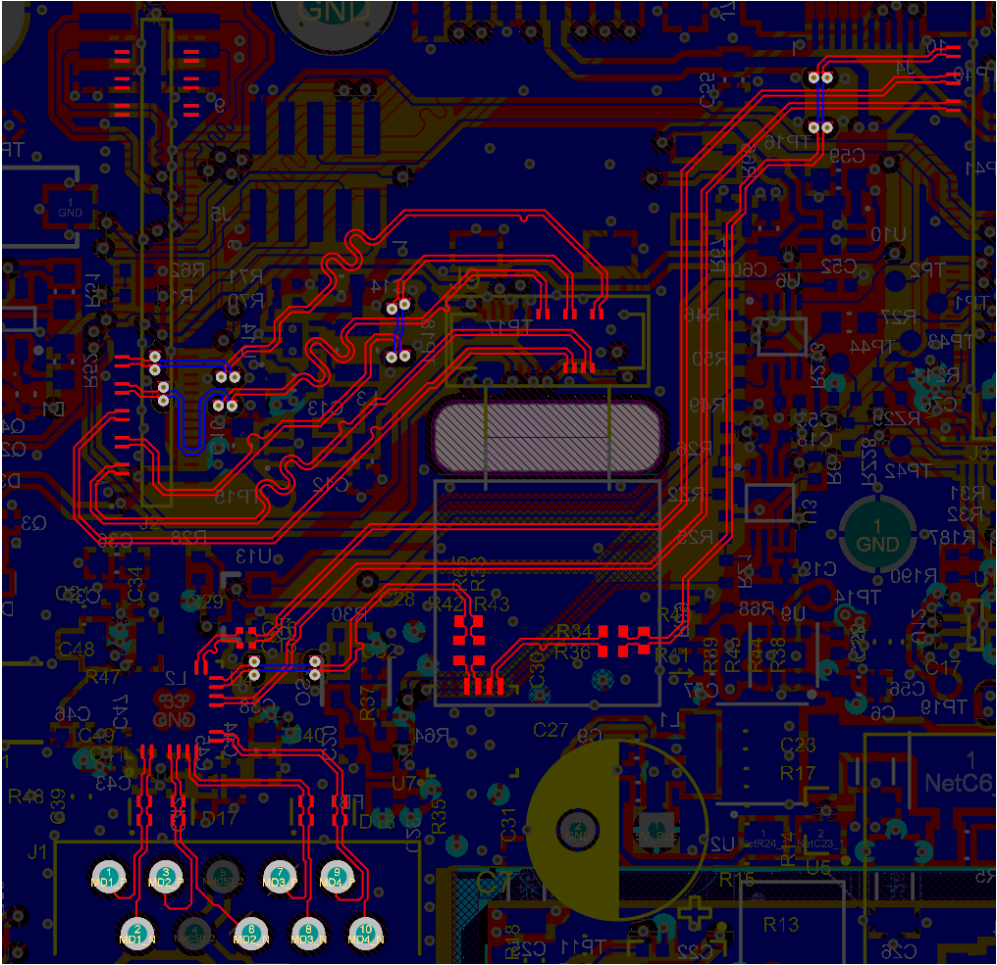
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ALL OTHER DIFFERENTIAL PAIRS ARE 100OHM +/-10%

MIPI, ETHERNET DIFFERENTIAL PAIRS



Transmission Line Structure Table

Target Impedance	Calculated Impedance	Trace layer	Lower Trace Width	Upper Trace Width	Gap	Reference layers
100	99.96	Top Layer	5.1mil(0.130mm)	5.1mil(0.130mm)	4.0mil(0.102mm)	Layer 2
100	99.96	Bottom Layer	5.1mil(0.130mm)	5.1mil(0.130mm)	4.0mil(0.102mm)	Layer 3

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